

















Layer	Name	Material	Thickness	Constant	
	Top Overlay				
	Top Solder	Solder Resist	0.013mm	3.8	
1	Top Layer		0.035mm		
	Dielectric 1	7628	0.200mm	4.6	
2	GND		0.018mm		
	Core	FR-4	1.065mm	4.5	
3	PWR		O. 018mm		
	Dielectric 2	7628	0.200mm	4.6	
4	Bottom Layer		0.035mm		
	Bottom Solder	Solder Resist	O.013mm	3.8	
	Bottom Overlay				

Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad	Pad Shape	Template
	253	0.300mm (11.81mil)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	(Mixed)
0	3	2.300mm (90.55mil)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	(Mixed)
	256 Total							